

CRYSTAL OSCILLATOR (SPXO)
OUTPUT : CMOS


Product Number (please contact us)
SG2016CAN: X1G004801xxxx00
SG-210STF: X1G004171xxxx00
SG3225CAN: X1G005961xxxx15
SG5032CAN: X1G004451xxxx00
SG7050CAN: X1G004481xxxx00

SG2016 / 3225 / 5032 / 7050CAN

SG-210STF

- Frequency : 20 standard frequencies
- Supply voltage : 1.8 V to 3.3 V Typ.
- Function : Standby($\overline{\text{ST}}$)
- Operating temperature : -40 °C to +105 °C


Specifications (characteristics)

Item	Symbol	Specifications					Conditions / Remarks			
Output frequency	fo	4 MHz 14.7456 MHz 25 MHz 33.3333 MHz	8 MHz 16 MHz 26 MHz 40 MHz	10 MHz 20 MHz 27 MHz 48 MHz	12 MHz 24 MHz 32 MHz 50 MHz	12.288 MHz 24.576 MHz 33.33 MHz 72 MHz				
Supply voltage	Vcc	1.60 V to 3.63 V					4 MHz ≤ fo ≤ 50 MHz, T_use = +105 °C Max.		Refer to Figure 1	
		1.71 V to 3.63 V					fo = 72 MHz, T_use = +85 °C Max.			
		2.25 V to 3.63 V					fo = 72 MHz, T_use = +105 °C Max.			
Storage temperature	T_stg	-55 °C to +125 °C					SG2016CAN			
		-40 °C to +125 °C					All others			
Operating temperature	T_use	-20 °C to +70 °C, -40 °C to +85 °C, -40 °C to +105 °C					See of figure *1			
Frequency tolerance	f_tol	±25 × 10 ⁻⁶					-20 °C to +70 °C			
		±50 × 10 ⁻⁶					-40 °C to +85 °C, -40 °C to +105 °C			
Current consumption	Icc	Vcc = 1.8 V ± 10 %	Vcc = 2.5 V ± 10 %		Vcc = 3.3 V ± 10 %					
		1.5 mA Max.	1.6 mA Max.		1.8 mA Max.		No load condition, 4 MHz ≤ fo ≤ 20 MHz			
		1.8 mA Max.	2.0 mA Max.		2.2 mA Max.		No load condition, 20 MHz < fo ≤ 40 MHz			
		2.1 mA Max.	2.4 mA Max.		2.6 mA Max.		No load condition, 40 MHz < fo ≤ 50 MHz			
		2.4 mA Max.	2.8 mA Max.		3.0 mA Max.		No load condition, fo = 72 MHz			
Stand-by current	I_std	2.1 µA Max.	2.5 µA Max.		2.7 µA Max.		ST =GND			
Symmetry	SYM	45 % to 55 %					50 % Vcc level, L_CMOS ≤ 15 pF			
Output voltage	VOH	90 % Vcc Min.						1.8 V ± 10 %	2.5 V ± 10 %	3.3 V ± 10 %
	VOL	10 % Vcc Max.					IOH	-1.5 mA	-3 mA	-4 mA
	VOH-2	Vcc - 0.4 V Min.					IOL	1.5 mA	3 mA	4 mA
	VOL-2	0.4 V Max.						1.8 V±10 %	2.5 V±10 %	3.3 V±10 %
							IOH	-3 mA	-4 mA	-6 mA
	IOL	3 mA	4 mA	6 mA						
Output load condition (CMOS)	L_CMOS	15 pF Max.								
Input voltage	VIH	80 % Vcc Min.					ST terminal			
	VIL	20 % Vcc Max.								
Rise time and Fall time	tr / tf	3 ns Max. 3.5 ns Max. (@1.8 V±10 %)					20 % Vcc to 80 % Vcc level, L_CMOS = 15 pF			
Start-up time	t_str	3 ms Max.					T = 0 at 90 % Vcc			
Frequency aging	f_age	±3 × 10 ⁻⁶ / year Max.					+25 °C, First year			

[Model : SG2016 / 3225 / 5032 / 7050CAN]

Product name **SG2016CAN 25.000000MHz T J H A**
(Standard form) ① ② ③ ④⑤⑥⑦
①Model ②Output(C: CMOS) ③Frequency ④Supply voltage
⑤Frequency tolerance ⑥Operating temperature range
⑦Internal identification code("A" is default)

④Supply voltage *See Figure 1	
T	1.8 V to 3.3 V Typ.
K	2.5 V to 3.3 V Typ.

⑤Frequency tolerance / ⑥Operating temperature range	
DB*	$\pm 25 \times 10^{-6}$ / -20 °C to +70 °C
JG	$\pm 50 \times 10^{-6}$ / -40 °C to +85 °C
JH	$\pm 50 \times 10^{-6}$ / -40 °C to +105 °C

* Please refer to Product number list on Full Data Sheet for available frequencies

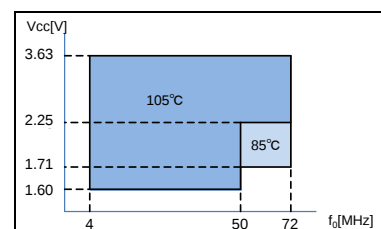


Figure 1 : The upper limit of Operating temperature and the related conditions

Please note that Supply voltage range (V_{CC}) depends on Output frequency (f_o) and upper limit of Operating temperature ($T_{\text{use}} \text{ Max.}$).

[Model : SG-210STF]

Product name **SG-210STF 25.000000MHz Y**
(Standard form) ① ②③ ④ ⑤
①Model ②Function(S: Standby) ③Supply voltage
④Frequency ⑤Frequency tolerance

③Supply voltage *See Figure 1	
T	1.8 V to 3.3 V Typ.

⑤Frequency tolerance	
S*	$\pm 25 \times 10^{-6}$ / -20 °C to +70 °C
L	$\pm 50 \times 10^{-6}$ / -40 °C to +85 °C
Y	$\pm 50 \times 10^{-6}$ / -40 °C to +105 °C

* Please refer to Product number list on Full Data Sheet for available frequencies



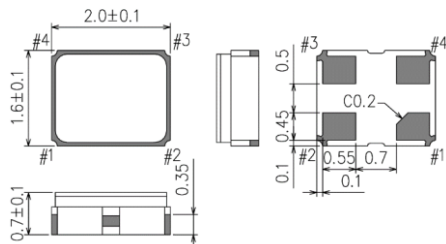
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(Unit:mm)

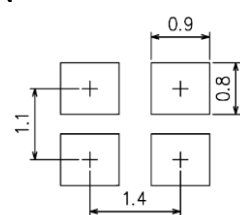
Footprint (Recommended)

(Unit:mm)

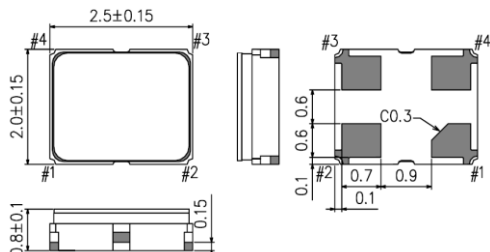
SG2016CAN



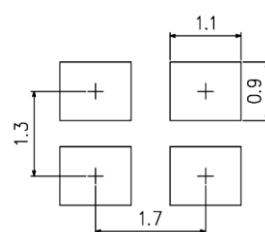
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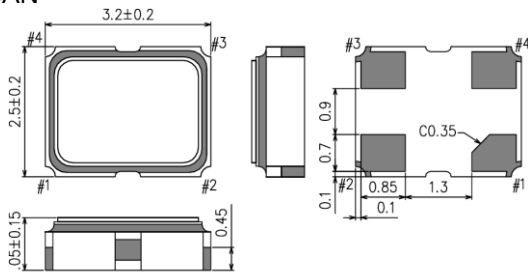
SG-210STF



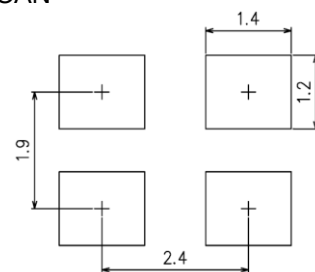
SG-210STF



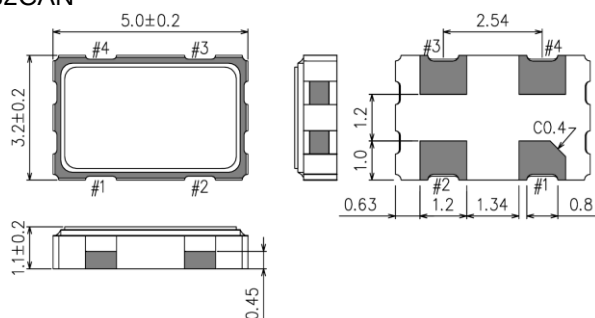
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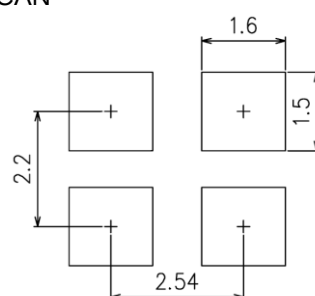
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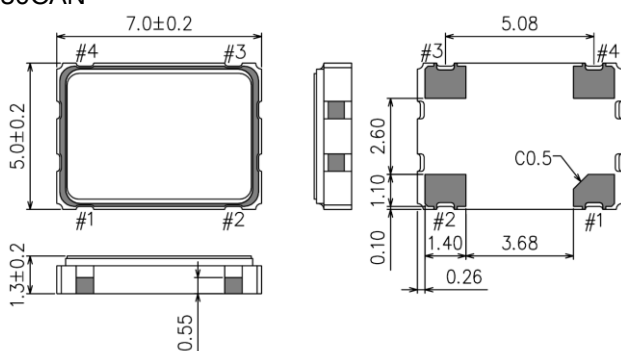
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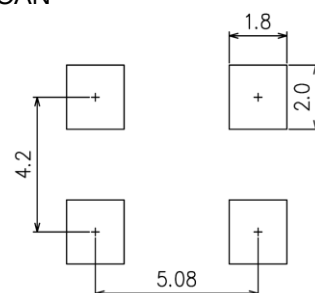
SG5032CAN



SG7050CAN



SG7050CAN



Pin Map

Pin	Connection	Function		
1	ST	ST terminal	ST function	Oscillator circuit
			HIGH or "open"	Oscillation
			LOW	Oscillation stop
2	GND	Ground	Output	
3	OUT	Clock output	Specified frequency: Enable	
4	V _{CC}	Power supply	High impedance: Disable	

■Notes: To maintain stable operation, provide a 0.01μF to 0.1μF by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between V_{CC} - GND).

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	► Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive. (Contains Pb in sealing glass, high melting temperature type solder or other.)
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